



December 14, 2021

To,

The Manager

Listing Operations

**BSE** Limited

Sir Phiroze Jeejeebhoy Towers

Dalal Street, Fort

Mumbai - 400 001

Scrip Code: 533080

ISIN: INE893J01029

To.

The Manager

Listing Department

National Stock Exchange of India Limited

Exchange Plaza,

Bandra Kurla Complex

Bandra (E), Mumbai-400051

Scrip Code: MOLDTKPAC

ISIN: INE893J01029

Dear Sir,

Sub: Intimation of the outcome of the QIP Committee meeting of Mold-Tek Packaging Limited (the "Company") held today in connection with the Qualified Institutions Placement ("QIP")

This is to inform you that subsequent to the approval accorded by the Board of Directors of the Company, at its meeting held on November 3, 2021 and the approval of the shareholders of the Company by way of a special resolution passed on December 6, 2021 for the QIP, the QIP Committee of the Company has, at its meeting held today i.e. December 14, 2021, *inter alia*, passed the following resolutions:

- a. Approved and adopted the preliminary placement document dated December 14, 2021 in connection with the QIP, (the "Preliminary Placement Document");
- b. Approved the opening of the QIP on December 14, 2021; and
- c. Approved the floor price of ₹722.40 per Equity Share for the QIP.

Further, the "Relevant Date" for this purpose, in terms of Regulation 171(a)(i) of the SEBI ICDR Regulations, is December 14, 2021 and accordingly the floor price in respect of the aforesaid QIP, based on the pricing formula as prescribed under Regulation 176(1) of the SEBI ICDR Regulations is ₹ 722.40 per Equity Share. The Company may at its discretion offer a discount of not more than 5% on the floor price so calculated for the QIP.

The meeting of the QIP Committee commenced at 7:00 PM and the meeting was concluded at 7:40 PM.

The Exchanges are requested to take the above on record, and the same may be treated as compliance under applicable clause(s) of the Securities and Exchange Board of India (Listing Obligations and Disclosure Requirements) Regulations, 2015, as amended.

Capitalized terms used herein shall have the respective meaning assigned to them in the Preliminary Placement Document unless specifically defined herein.

Yours truly,

For Mold-Tek Packaging Limited

Thakur Vishal Singh Company Secretary

Corporate Office: